

4A, 50V - 1000V Standard Bridge Rectifier

FEATURES

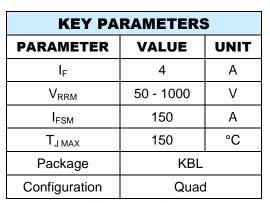
- Glass passivated chip junction
- Ideal for printed circuit board
- Reliable low cost construction
- UL Recognized File # E-326243
- RoHS Compliant

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

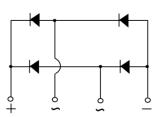
MECHANICAL DATA

- · Case: KBL
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 5.60g (approximately)









ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)									
PARAMETER	SYMBOL	KBL 401G	KBL 402G	KBL 403G	KBL 404G	KBL 405G	KBL 406G	KBL 407G	UNIT
Marking code on the device		KBL 401G	KBL 402G	KBL 403G	KBL 404G	KBL 405G	KBL 406G	KBL 407G	
Repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Forward current	I _F	4					Α		
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	150					А		
Rating for fusing (t<8.3ms)	l ² t	93					A ² s		
Junction temperature	TJ	- 55 to +150					°C		
Storage temperature	T _{STG}	- 55 to +150					°C		

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THERMAL PERFORMANCE						
PARAMETER	SYMBOL	TYP	UNIT			
Junction-to-lead thermal resistance	$R_{\Theta JL}$	2.4	°C/W			
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	19	°C/W			

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT	
Forward voltage per diode ⁽¹⁾	I _F = 2A, T _J = 25°C	V	-	1.0	V	
	I _F = 4A, T _J = 25°C	V _F	-	1.1	V	
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 25°C		-	10	μΑ	
	T _J = 125°C	I _R	-	500	μΑ	

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION						
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING				
KBL40xG	KBL	100 / Tray				

Notes:

1. "x" defines voltage from 50V(KBL401G) to 1000V(KBL407G)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

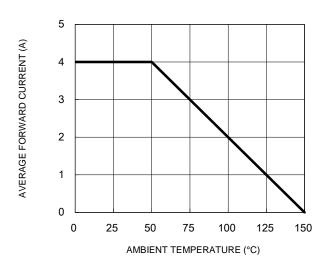


Fig.3 Typical Reverse Characteristics

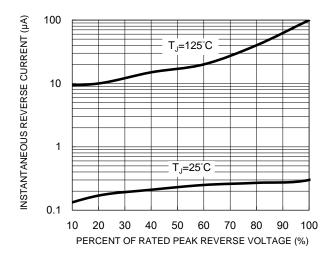


Fig.2 Typical Junction Capacitance

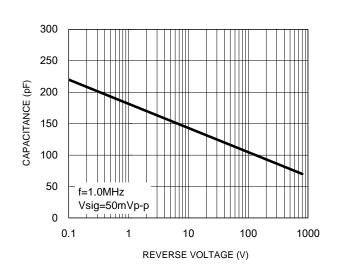


Fig.4 Typical Forward Characteristics

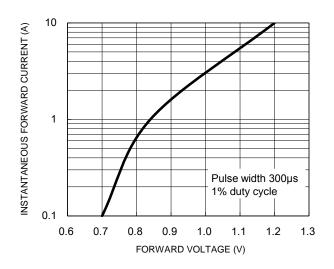
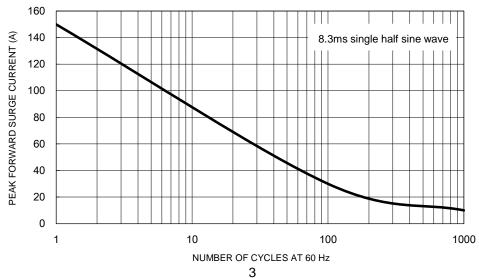


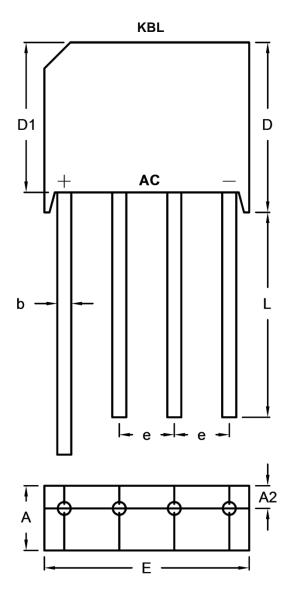
Fig.5 Maximum Non-Repetitive Forward Surge Current







PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min.	Max.	Min.	Max.	
Α	5.50	6.50	0.217	0.256	
A2	2.10 (TYP)		0.083 (TYP)		
b	1.20	1.40	0.047	0.055	
D	15.20	16.30	0.598	0.642	
D1	13.70	14.10	0.539	0.555	
E	18.50	19.50	0.728	0.768	
е	4.60	5.60	0.181	0.220	
L	19.00	-	0.748	-	

MARKING DIAGRAM



P/N = Marking Code YWW = Date Code F = Factory Code



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